

ON Semiconductor® FCH104N60F-F085

N-Channel SuperFET II FRFET MOSFET

600 V, 37 A, 104 mΩ

Features

- Typical R_{DS(on)} = 91 mΩ at V_{GS} = 10 V, I_D = 18.5 A
- Typical Q_{q(tot)} = 109 nC at V_{GS} = 10V, I_D = 18.5 A
- UIS Capability
- Qualified to AEC Q101
- RoHS Compliant

Description

SuperFET® II MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently SuperFETII is very well suited for the Soft switching and Hard Switching topologies like High Voltage Full Bridge and Half Bridge DC-DC, Interleaved Boost PFC, Boost PFC for HEV-EV automotive. SuperFET II FRFET® MOSFET's optimized body diode reverse

recovery performance can remove additional component and improve system reliability.

Maximum Ratings T_C = 25°C unless otherwise noted



Application



Automotive DC/DC converter for HEV

Symbol	Parameter		Ratings	Units	
V _{DSS}	Drain to Source Voltage		600	V	
V _{GS}	Gate to Source Voltage		±20	V	
I _D		T _C = 25°C	37	А	
	Drain Current - Continuous (V _{GS} =10) (Note 1)	T _C = 100°C	24	А	
	Pulsed Drain Current		See Fig 4	А	
E _{AS}	Single Pulse Avalanche Rating	(Note 2)	809	mJ	
du/dt	MOSFET dv/dt		100	1//20	
av/at	Peak Diode Recovery dv/dt	(Note 3)	50	v/ns	
P _D	Power Dissipation		357	W	
	Derate Above 25°C		2.85	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature		-55 to + 150	°C	
$R_{ ext{ heta}JC}$	Maximum Thermal Resistance Junction to Case		0.35	°C/W	
R_{\thetaJA}	Maximum Thermal Resistance Junction to Ambie	nt (Note 4)	40	°C/W	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FCH104N60F	FCH104N60F-F085	TO-247	-	-	30

Notes:

1: Current is limited by bondwire configuration.

2: Starting T_J = 25°C, L = 35mH, I_{AS} = 6.8A, V_{DD} = 100V during inductor charging and V_{DD} = 0V during time in avalanche. 3: I_{SD} ≤ 18.5A, di/dt ≤ 200 A/us, V_{DD} ≤ 380V, starting T_J = 25°C.

4: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design, while R_{0JA}is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

Symbol	Parameter	Test Conditions		Min	Тур	Max	Units
Off Cha	racteristics						
Bypss	Drain to Source Breakdown Voltage	$I_{D} = 250 \mu A V_{CS} = 0 V$		600	-	-	V
		V _{DS} =600V,	T ₁ = 25°C	-	-	10	μA
IDSS	Drain to Source Leakage Current	$V_{GS} = 0V$	$T_{\rm J} = 150^{\rm o} {\rm C}({\rm Note}\ 5)$	-	-	1	mA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V$		-	-	±100	nA
On Cha	racteristics			-			
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250µA		3.0	4.0	5.0	V
· 03(iii)		In = 18.5A.	T ₁ = 25°C	-	91	104	mΩ
r _{DS(on)}	Drain to Source On Resistance	V _{GS} = 10V	$T_{\rm J} = 150^{\rm o} {\rm C}({\rm Note}\ 5)$	-	217	275	mΩ
C _{iss}	Input Capacitance	V _{DS} = 100V, V _{GS} = 0V, f = 1MHz		-	4302	-	pF
C _{oss}	Output Capacitance			-	134	-	pF
C _{rss}	Reverse Transfer Capacitance			-	1.7	-	pF
R _g	Gate Resistance	f = 1MHz		-	0.49	-	Ω
Q _{g(ToT)}	Total Gate Charge	$V_{DD} = 380V$ $I_D = 18.5A$ $V_{GS} = 10V$		-	109	139	nC
Q _{g(th)}	Threshold Gate Charge			-	8	11	nC
Q _{gs}	Gate to Source Gate Charge			-	23	-	nC
Q _{gd}	Gate to Drain "Miller" Charge			-	46	-	nC
Switch	ing Characteristics						
t _{on}	Turn-On Time			-	58	78	ns
t _{d(on)}	Turn-On Delay Time		-	-	35	-	ns
t _r	Rise Time	V_{DD} = 380V, I _D = 18.5A, V_{GS} = 10V, R _G = 4.7Ω		-	23	-	ns
t _{d(off)}	Turn-Off Delay Time			-	94	-	ns
t _f	Fall Time			-	5	-	ns
t _{off}	Turn-Off Time			-	98	131	ns
Drain-S	ource Diode Characteristics						
V _{SD}	Source to Drain Diode Voltage	I _{SD} = 18.5A, V _{GS} = 0V		-	-	1.2	V
Т	Reverse Recovery Time	I _F = 18.5A, dI _{SD} /dt = 100A/μs		-	162	-	ns
'm	Pavarsa Recovery Charge	V _{DD} = 480V		-	1223	-	nC





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